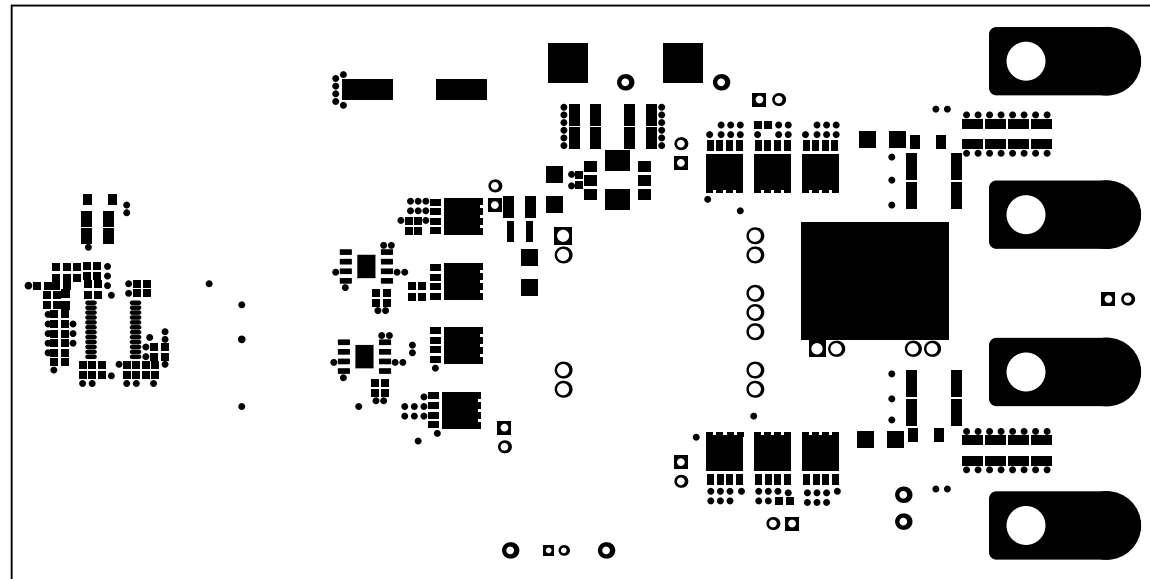
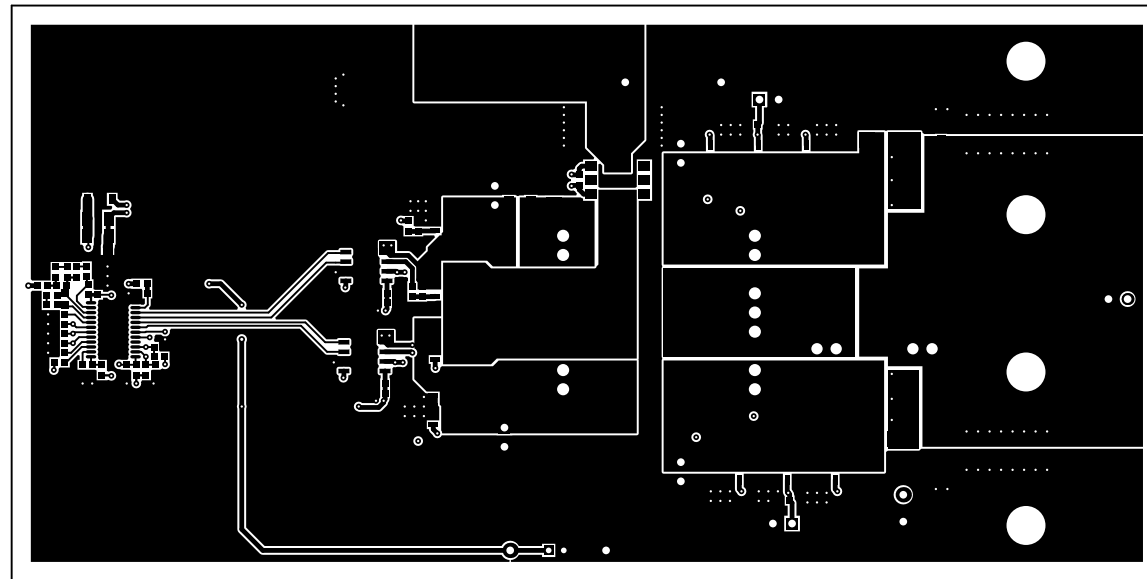


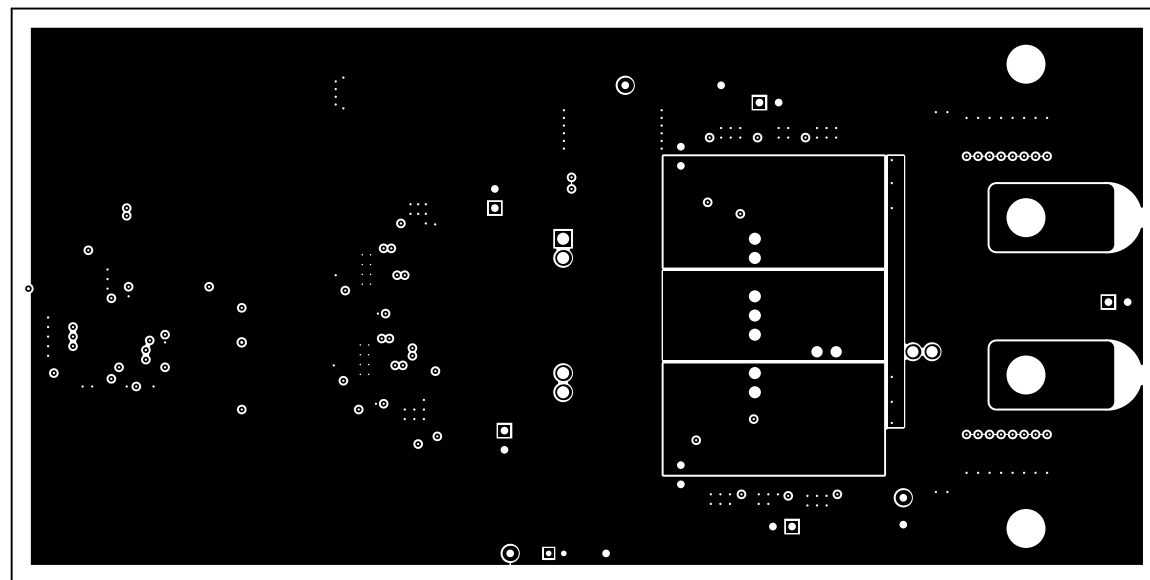
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay | TID #: | | |
| PLOT NAME = Top Overlay | GENERATED : 7/12/2017 11:05:30 AM | TEXAS INSTRUMENTS | |



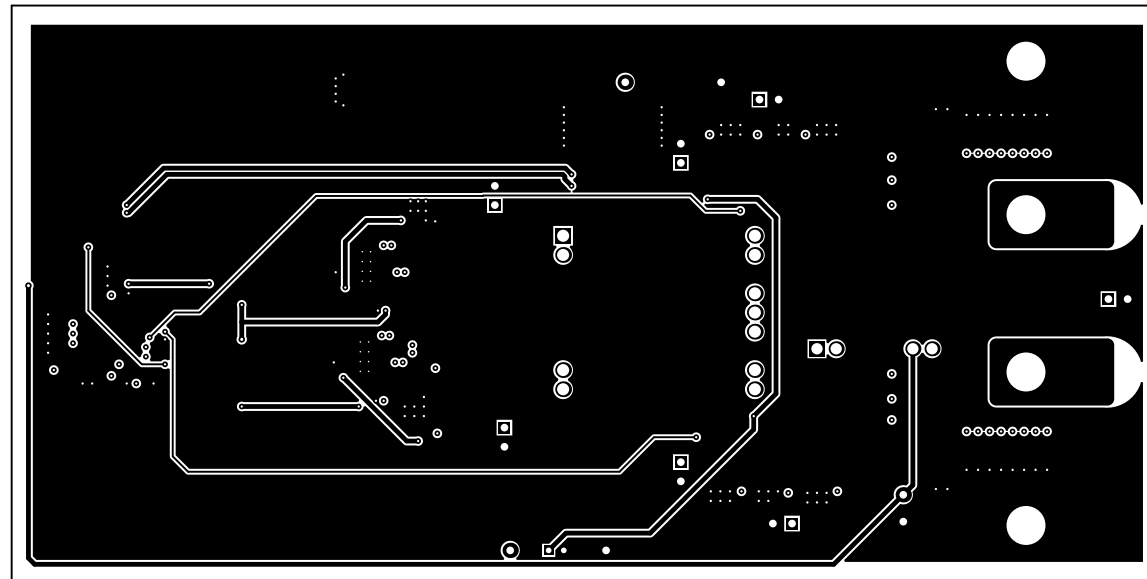
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder | TID #: | | |
| PLOT NAME = Top Solder Mask | GENERATED : 7/12/2017 11:05:32 AM | TEXAS INSTRUMENTS | |



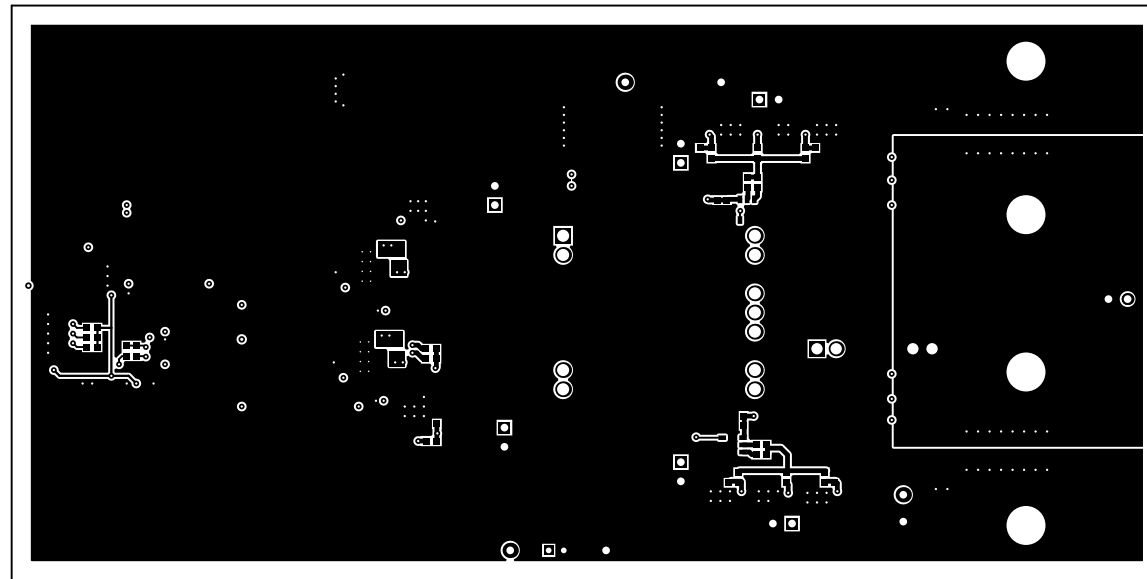
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | TID #: | | |
| PLOT NAME = Top Layer | GENERATED : 7/12/2017 11:05:34 AM | TEXAS INSTRUMENTS | |



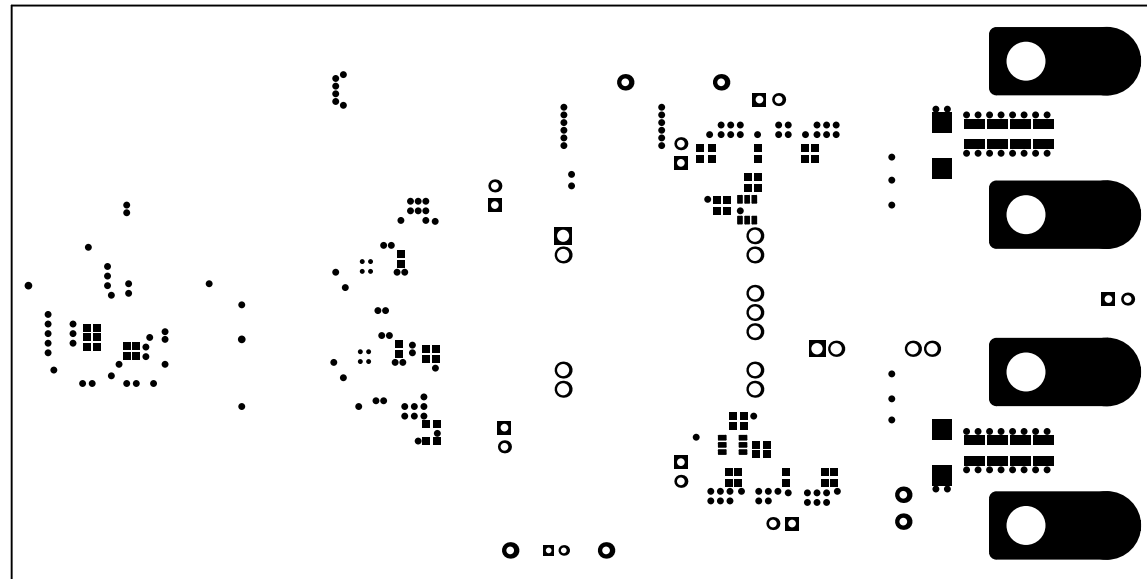
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = | TID #: | | |
| PLOT NAME = Signal Layer 1 | GENERATED : 7/12/2017 11:05:36 AM | TEXAS INSTRUMENTS | |



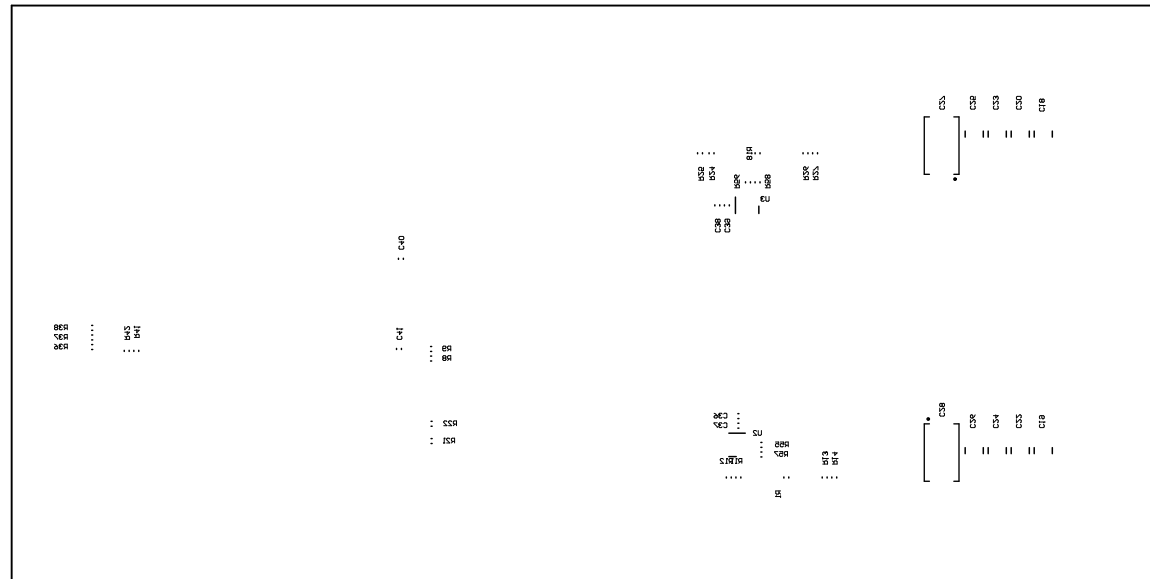
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = | TID #: | | |
| PLOT NAME = Signal Layer 2 | GENERATED : 7/12/2017 11:05:38 AM | TEXAS INSTRUMENTS | |



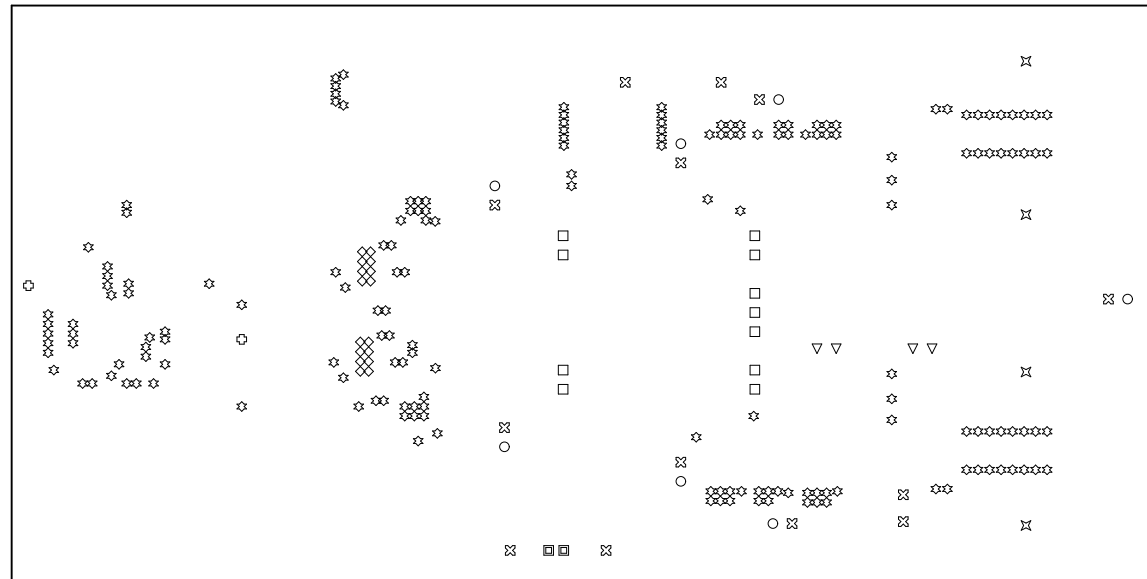
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | TID #: | | |
| PLOT NAME = Bottom Layer | GENERATED : 7/12/2017 11:05:39 AM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | TID #: | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 7/12/2017 11:05:41 AM | TEXAS INSTRUMENTS | |

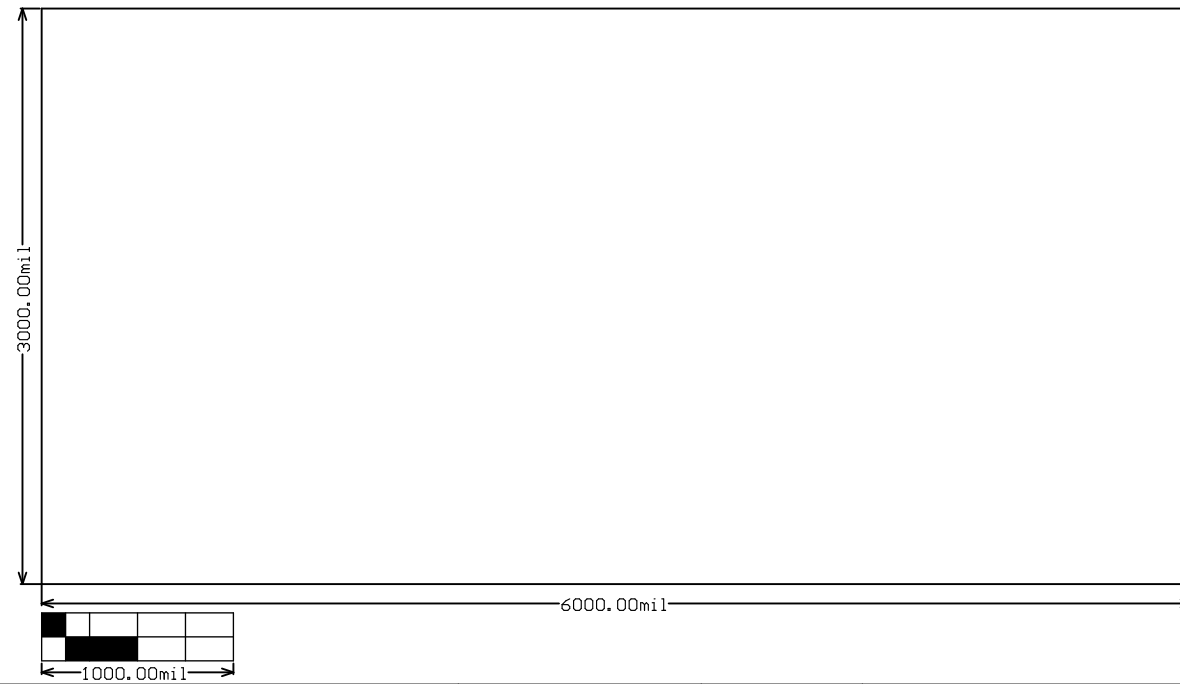


| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | TID #: | | |
| PLOT NAME = Bottom Overlay | GENERATED : 7/12/2017 11:05:43 AM | TEXAS INSTRUMENTS | |



| Symbol | Quantity | Finished Hole Size | Plated | Hole Type | Drill Layer Pair | Hole Tolerance |
|--------|-----------|---------------------|--------|-----------|--------------------------|----------------|
| ◇ | 16 | 7.87mil (0.200mm) | PTH | Round | Top Layer - Bottom Layer | |
| ☆ | 177 | 12.00mil (0.305mm) | PTH | Round | Top Layer - Bottom Layer | |
| ⊗ | 2 | 16.00mil (0.406mm) | PTH | Round | Top Layer - Bottom Layer | |
| ■ | 2 | 29.53mil (0.750mm) | PTH | Round | Top Layer - Bottom Layer | |
| ⊗ | 13 | 40.00mil (1.016mm) | PTH | Round | Top Layer - Bottom Layer | |
| ○ | 7 | 40.16mil (1.020mm) | PTH | Round | Top Layer - Bottom Layer | |
| ▽ | 4 | 59.06mil (1.500mm) | PTH | Round | Top Layer - Bottom Layer | |
| □ | 11 | 62.99mil (1.600mm) | PTH | Round | Top Layer - Bottom Layer | |
| ⊗ | 4 | 203.15mil (5.160mm) | PTH | Round | Top Layer - Bottom Layer | |
| | 236 Total | | | | | |

| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | TID #: | | |
| PLOT NAME = Drill Drawing | GENERATED : 7/12/2017 11:05:45 AM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01407 | REV: B | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions | TID #: | | |
| PLOT NAME = Board Dimensions | GENERATED : 7/12/2017 11:05:47 AM | TEXAS INSTRUMENTS | |

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